



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

HP FF 12500E Fan Tray Assembly(JG805A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	1
Batteries	All types including standard alkaline and lithium coin or button style batteries	0
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Screw driver	2 #

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Unscrew the screws on protection cover 1 and protection cover 2, and then remove protection cover 1 and protection cover 2 from fan frame 5.
2. Unscrew the screws on fan protect Net 3,fan protect Net 4,fan 6 and fan 7, and then remove protect Net 3,fan protect Net 4,fan 6 and fan 7 from fan frame 5.
3. Unscrew the screws on pcb 8,then remove the pcb 8 from fan frame 5.
4. Unscrew the screws on handle 9, and then remove handle 9 from fan frame 5.
5. Remove shielding finger 10 from fan frame 5.
6. Remove film 11 from from fan frame 5.
7. Remove handle warning label 12 and fan caution label 13 from from fan frame 5.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

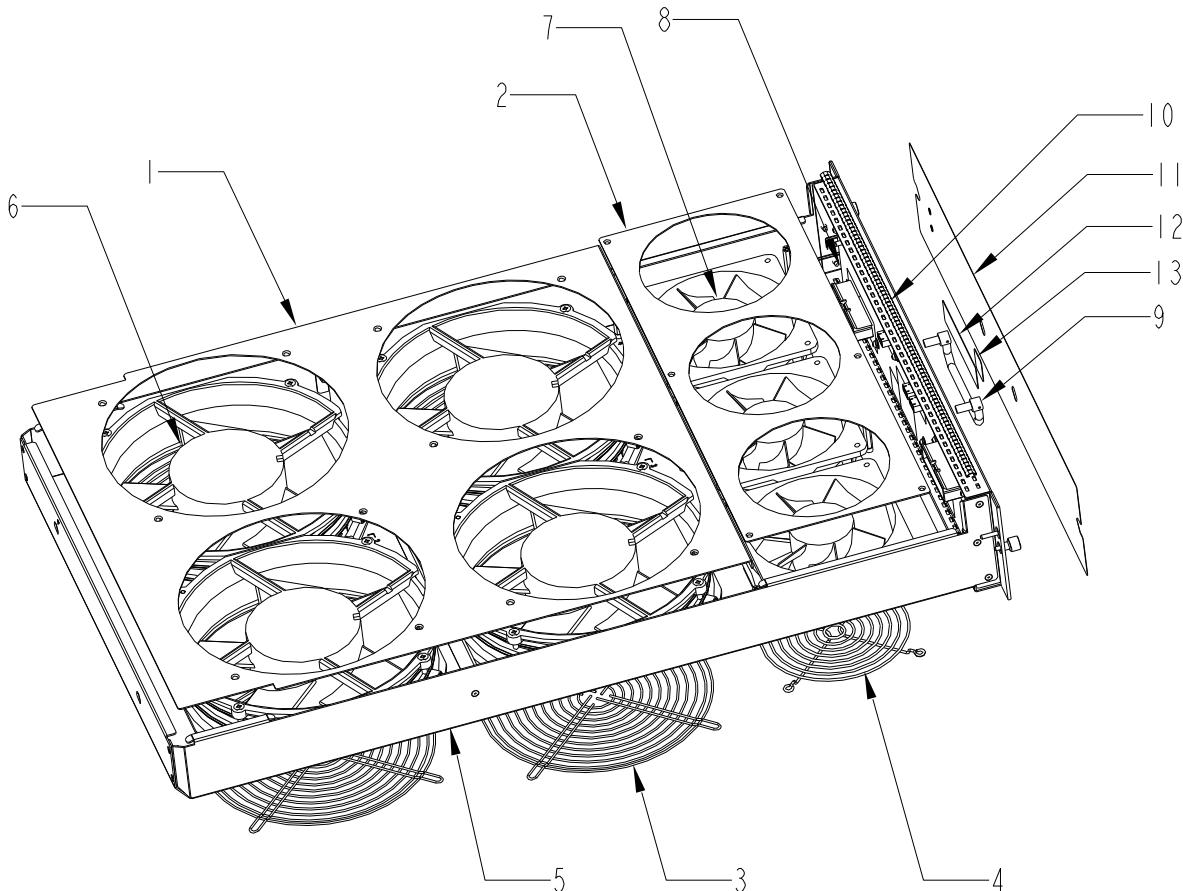


Figure 1

3.3 Material of the facility built

Table 1

Facility	Components	Material	Weight(g)	Weight percentage	Selective treatment for materials and components	Details
1	Fe	Fe	671.0	6.81%		Fe recycling
2	Fe	Fe	198.0	2.06%		Fe recycling
3	Fe	Fe	66.4*4	2.67%		Fe recycling
4	Fe	Fe	39.5*3	1.20%		Fe recycling
5	Fe	Fe	2515.5	21.83%		Fe recycling
6	Pla,Fe	Pla,Fe	1300.0*4	52.79%	Plastic containing brominated flame retardants	Pla&Fe recycling
7	Pla,Al	Pla,Al	200.0*3	6.09 %	Plastic containing brominated flame retardants	Pla&Al recycling
8	Complex PWB	Complex PWB	240.0	2.43%	The surface If PCB is greater than 10 square centimeters	
9	Fe	Fe	40.0	0.40%		Fe recycling
10	Be-Cu	Be-Cu	1.6	0.00%		Cu recycling

4. Revised record

Date	Version	Author	Modify content
2013.10.18	V0	Chen Longjun	Initial version